

## NOTES: UNLESS OTHERWISE SPECIFIED

1. THIS COMPONENT CONFORMS TO UL60950. UL FILE NO. IS: E216117.

WARNING:
THIS COMPONENT IS RECOGNIZED BY ONE OR MORE SAFETY AGENCIES SUCH AS UL, VDE, CSA AND/OR TUV. ALL ENGINEERING CHANGES MUST HAVE PRIOR APPROVAL BY THE DESIGN CENTER QUALITY DEPARTMENT FOR SAFETY AGENCY COMPLIANCE.

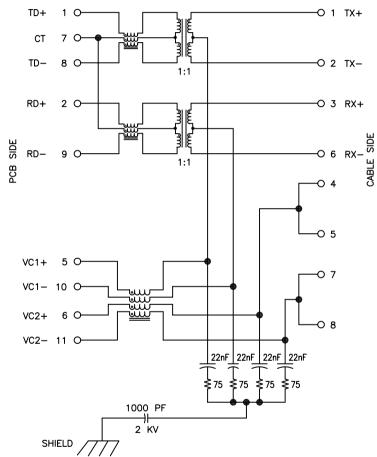
2.

NOTICE:	THIS IS A ROHS COMPLIANT
RoHS	THIS IS A ROHS COMPLIANT COMPONENT/PRODUCT. ALL ENGINEERING CHANGES MUST HAVE PRIOR APPROVAL BY THE DESIGN CENTER.

- PLASTIC HOUSING: THERMOPLASTIC MATERIAL WITH FLAMMABILITY RATING UL 94V-0 OR BETTER.
- 4. CONTACT BASE MATERIAL: PHOSPHOR BRONZE.
- 5. CONTACTS UNDERPLATE: 30-50 MICROINCHES DUCTILE NICKEL.
- 6. CONTACTS PLATING: 30 MICROINCHES GOLD PLATING.
- SOLDER TAIL PLATING MATERIAL: 200-500 MICROINCHES 100% TIN, MATTE FINISH.
- 8. METAL SHIELD: NICKEL PLATING ON COPPER ALLOY.

JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS
PART 68 SUBPART F.

- 10. PCB PLATING: EG.
- 11. SOLDERABILITY: CONFORMS TO ANSI/J-STD-002, IPC/EIA J-STD-003A.
- 12. OPERATING TEMPERATURE: 0°C TO +70°C
- 13. STORAGE TEMPERATURE: -20°C TO +125°C
- 14. JEDEC MOISTURE: LEVEL 1.
- 15. DIMENSIONS ARE IN INCHES [MILLIMETERS] WITH THE FOLLOWING TOLERANCES: [MILLIMETERS] ARE FOR REFERENCE ONLY.  $.XX = \pm .02 \quad [\pm 0.5] \\ .XXX = \pm .010 \quad [\pm 0.25]$



ELECTRICAL CHARACTERISTICS AT +25°C UNLESS OTHERWISE SPECIFIED (FOR REFERENCE ONLY. USED FOR CUSTOMER INFORMATION.)

(FOR REFERENCE ONLY. USED FOR CUSTOMER INFORMATION.)						
PARAMETER	SPECIFICATION					
OPERATING TEMP	0°C-70°C					
TURNS RATIO	1 : 1 ±2%					
POLARITY	PER SCHEMATIC					
	100 KHz	Hz				
INSERTION LOSS	-1.2 dB MAX	-0.2-0.002*f <sup>1.4</sup> dB MAX				
RETURN LOSS	.1-30 MHz	30-60 MHz	60-80 MHz			
$(Z_{out} = 100 \text{ OHM } \pm 15\%)$		-10+20*LOG <sub>10</sub> (f/60 MHz) dB MIN	-10 dB MIN			
INDUCTANCE (OCL) MEDIA SIDE, 0°C-70°C)	350 uH MIN	/MEASURED AT 100 KH- 100 VRMS				
	1 MHz	10-100 MHz				
CROSSTALK, ADJACENT CHANNELS	-50 dB MIN	-55+22*LOG <sub>10</sub> (f/10) dB MIN				
COMMON MODE	2 MHz	30-200 MHz				
REJECTION RATIO	-50 dB MIN	-15+20*LOG <sub>10</sub> (f/200) dB MIN				
DC RESISTANCE, 1/2 WINDING	.65 OHMS MAX					
DC RESISTANCE IMBALANCE	±.065 OHMS MAX (CENTER TAP SYMMETRY)					
DC CURRENT/VOLTAGE RATING - PSE PINS	350 mA, @ 57 V (CONTINUOUS)					
INPUT — OUTPUT ISOLATION	2250 VDC MIN @ 60 SECONDS					

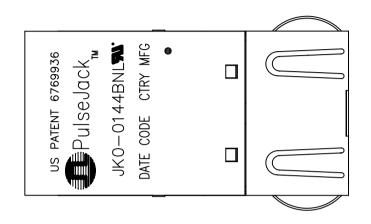
NOTE: f IS FREQUENCY IN MHz.

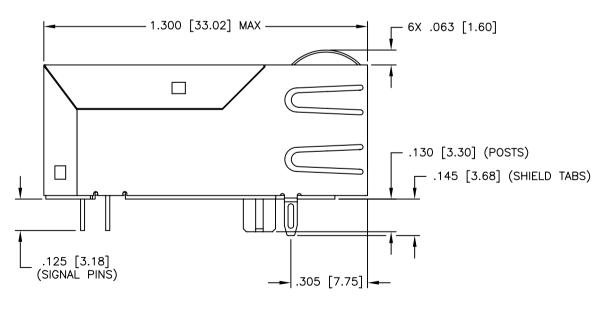
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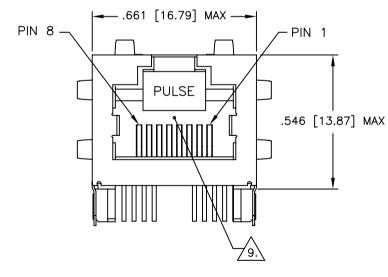
PULSE CONFIDENTIAL	PRODUCT DESCRIPTION	PS DRAWING	SHEET:	DWG. NO./ PART NO.	REV.
PROPRIETARY	CONN,RJ45,1X1,100P,1:1,TY	PS-2390.012-A	1	JK0-0144BNL	M10

**SCHEMATIC** 





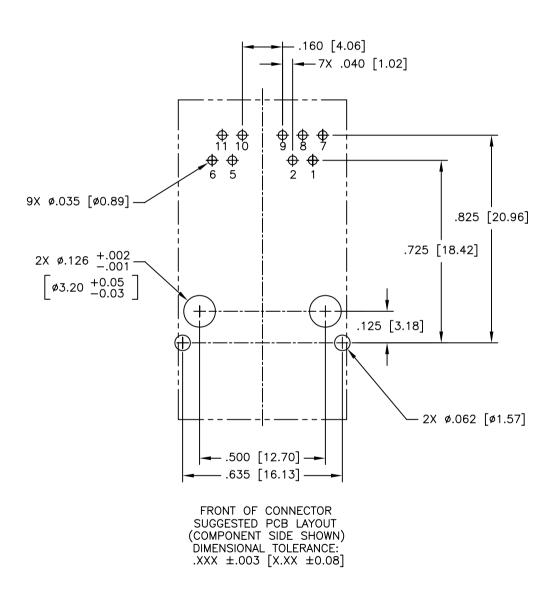


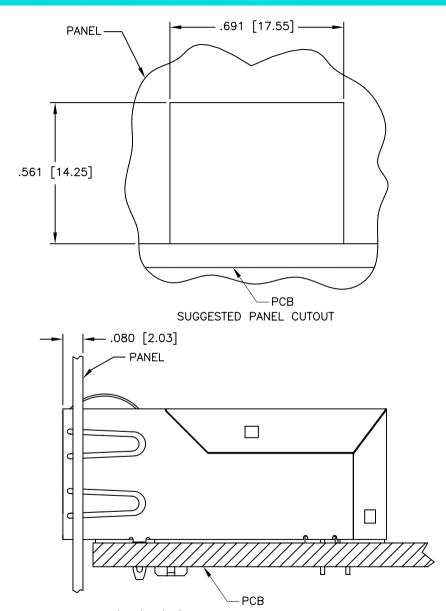


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PULSE CONFIDENTIAL	PRODUCT DESCRIPTION	PS DRAWING	SHEET:	DWG. NO./ PART NO.	REV.
PROPRIETARY	CONN,RJ45,1X1,100P,1:1,TY	PS-2390.012-A	2	JK0-0144BNL	M10







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PULSE CONFIDENTIAL	PRODUCT DESCRIPTION	PS DRAWING	SHEET:	DWG. NO./ PART NO.	REV.
PROPRIETARY	CONN,RJ45,1X1,100P,1:1,TY	PS-2390.012-A	3	JK0-0144BNL	M10